# imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



## Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China





## STGW35HF60WDI

## 35 A, 600 V ultrafast IGBT with low drop diode

### Features

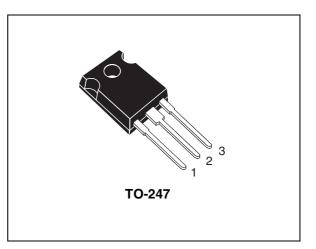
- Improved E<sub>off</sub> at elevated temperature
- Low C<sub>RES</sub> / C<sub>IES</sub> ratio (no cross-conduction susceptibility)
- Low V<sub>F</sub> soft recovery antiparallel diode

### **Applications**

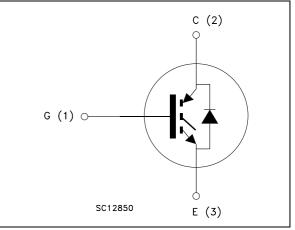
- Welding
- Induction heating
- Resonant converters

## Description

This ultrafast IGBT is developed using a new planar technology to yield a device with tighter switching energy variation ( $E_{off}$ ) versus temperature. The suffix "W" denotes a subset of products designed for high switching frequency operation (over 100 kHz).



#### Figure 1. Internal schematic diagram



#### Table 1. Device summary

Order code	Marking	Package	Packaging
STGW35HF60WDI	GW35HF60WDI	TO-247	Tube
STGWA35HF60WDI	35HF60WDI	TO-247 long leads	lube

## Contents

1	Electrical ratings	2
2	Electrical characteristics	3
	2.1 Electrical characteristics (curves)	5
3	Test circuits	8
4	Package mechanical data	9
5	Revision history	13



## 1 Electrical ratings

	Table 2.	Absolute	maximum	ratings
--	----------	----------	---------	---------

Symbol	nbol Parameter		Value	l lmit
Symbol	Parameter	TO-247	TO-247 long leads	Unit
V <sub>CES</sub>	Collector-emitter voltage ( $V_{GE} = 0$ )		600	V
I <sub>C</sub> <sup>(1)</sup>	Continuous collector current at $T_C = 25 \ ^{\circ}C$	60	70	А
I <sub>C</sub> <sup>(1)</sup>	Continuous collector current at T <sub>C</sub> = 100 °C	35	40	Α
I <sub>CL</sub> <sup>(2)</sup>	Turn-off latching current	80		Α
I <sub>CP</sub> <sup>(3)</sup>	Pulsed collector current	150		Α
$V_{GE}$	Gate-emitter voltage	± 20		V
١ <sub>F</sub>	Diode RMS forward current at $T_{C}$ = 25 °C	30		Α
I <sub>FSM</sub>	Surge non repetitive forward current t <sub>p</sub> = 10 ms sinusoidal	130		А
P <sub>TOT</sub>	Total dissipation at $T_C = 25 \ ^{\circ}C$	200 260		W
T <sub>stg</sub>	Storage temperature			ംറ
Тj	Operating junction temperature	– 55 to 150		C

1. Calculated according to the iterative formula:

$$I_{C}(T_{C}) = \frac{T_{j(max)} - T_{C}}{R_{thj-c} \times V_{CE(sat)(max)}(T_{j(max)}, I_{C}(T_{C}))}$$

2. Pulse width limited by maximum junction temperature and turn-off within RBSOA

3.  $V_{CLAMP}$  = 80% ( $V_{CES}$ ),  $V_{GE}$  = 15 V,  $R_G$  = 10  $\Omega$ ,  $T_J$  = 150 °C

	Table 3.	Thermal	data
--	----------	---------	------

Symbol	Parameter		Unit	
Symbol	Falameter	TO-247 TO-247 long lead		Onit
Р	Thermal resistance junction-case IGBT	0.63	0.48	°C/W
R <sub>thj-case</sub>	Thermal resistance junction-case diode	1.5		°C/W
R <sub>thj-amb</sub>	Thermal resistance junction-ambient	50		°C/W



## 2 Electrical characteristics

(T<sub>J</sub> = 25 °C unless otherwise specified)

Table 4.	Static					
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)CES</sub>	Collector-emitter breakdown voltage (V <sub>GE</sub> = 0)	I <sub>C</sub> = 1 mA	600			V
V <sub>CE(sat)</sub>	Collector-emitter saturation voltage	V <sub>GE</sub> = 15 V, I <sub>C</sub> = 20 A V <sub>GE</sub> = 15V, I <sub>C</sub> = 20 A,T <sub>J</sub> = 125 °C		1.9 1.65	2.5	V V
V <sub>GE(th)</sub>	Gate threshold voltage	$V_{CE} = V_{GE}, I_C = 1 \text{ mA}$	3.75		5.75	V
I <sub>CES</sub>	Collector cut-off current $(V_{GE} = 0)$	V <sub>CE</sub> = 600 V V <sub>CE</sub> = 600 V, T <sub>J</sub> = 125 °C			250 1	μA mA
I <sub>GES</sub>	Gate-emitter leakage current (V <sub>CE</sub> = 0)	V <sub>GE</sub> = ±20 V			± 100	nA
9 <sub>fs</sub>	Forward transconductance	$V_{CE} = 15 V, I_{C} = 20 A$		15		S

#### Table 4. Static

#### Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C <sub>ies</sub> C <sub>oes</sub> C <sub>res</sub>	Input capacitance Output capacitance Reverse transfer capacitance	V <sub>CE</sub> = 25 V, f = 1 MHz, V <sub>GE</sub> = 0	-	2400 235 50	-	pF pF pF
Q <sub>g</sub> Q <sub>ge</sub> Q <sub>gc</sub>	Total gate charge Gate-emitter charge Gate-collector charge	$V_{CE} = 390 \text{ V}, I_{C} = 20 \text{ A},$ $V_{GE} = 15 \text{ V},$ <i>(see Figure 17)</i>	-	140 13 52	-	nC nC nC

#### Table 6. Switching on/off (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub>	Turn-on delay time	$V_{CC} = 390 \text{ V}, \text{ I}_{C} = 20 \text{ A}$		30		ns
t <sub>r</sub>	Current rise time	R <sub>G</sub> = 10 Ω, V <sub>GE</sub> = 15 V,	-	15	-	ns
(di/dt) <sub>on</sub>	Turn-on current slope	(see Figure 16)		1650		A/µs
t <sub>d(on)</sub>	Turn-on delay time	$V_{CC} = 390 \text{ V}, \text{ I}_{C} = 20 \text{ A}$		30		ns
t <sub>r</sub>	Current rise time	R <sub>G</sub> = 10 Ω, V <sub>GE</sub> = 15 V,	-	15	-	ns
(di/dt) <sub>on</sub>	Turn-on current slope	T <sub>J</sub> = 125 °C <i>(see Figure 16)</i>		1600		A/µs



	•					
t <sub>r</sub> (V <sub>off</sub> )	Off voltage rise time	$V_{\rm CC} = 390$ V, $I_{\rm C} = 20$ A,		30		ns
t <sub>d</sub> ( <sub>off</sub> )	Turn-off delay time	$R_{GE} = 10 \ \Omega, V_{GE} = 15 \ V$	-	175	-	ns
t <sub>f</sub>	Current fall time	(see Figure 16)		40		ns
t <sub>r</sub> (V <sub>off</sub> ) t <sub>d</sub> ( <sub>off</sub> ) t <sub>f</sub>	Off voltage rise time Turn-off delay time Current fall time	$V_{CC} = 390 \text{ V}, I_C = 20 \text{ A},$ $R_{GE} = 10 \Omega, V_{GE} = 15 \text{ V},$ $T_J = 125 \text{ °C}$ <i>(see Figure 16)</i>	-	50 225 70	-	ns ns ns

 Table 6.
 Switching on/off (inductive load)

 Table 7.
 Switching energy (inductive load)

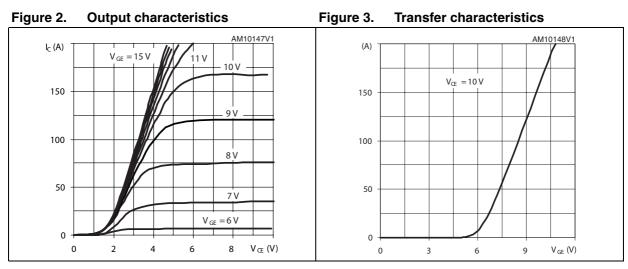
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
E <sub>off</sub>	Turn-off switching losses	$V_{CC} = 390 \text{ V}, I_C = 20 \text{ A}$ $R_G = 10 \Omega, V_{GE} = 15 \text{ V},$ <i>(see Figure 18)</i>	-	185		μJ
E <sub>off</sub>	Turn-off switching losses		-	350	530	μJ

 Table 8.
 Collector-emitter diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>F</sub>	Forward on-voltage	I <sub>F</sub> = 20 A I <sub>F</sub> = 20 A, T <sub>J</sub> = 125 °C	-	1.3 1.1	1.7	V V
t <sub>rr</sub> Q <sub>rr</sub> I <sub>rrm</sub>	Reverse recovery time Reverse recovery charge Reverse recovery current	I <sub>F</sub> = 20 A,V <sub>R</sub> = 50 V, di/dt = 100 A/μs <i>(see Figure 19)</i>	-	85 240 5.2	-	ns nC A
t <sub>rr</sub> Q <sub>rr</sub> I <sub>rrm</sub>	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_F = 20 \text{ A}, V_R = 50 \text{ V},$ $T_J = 125 \text{ °C}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}$ <i>(see Figure 19)</i>	-	230 930 8.7	-	ns nC A



#### **Electrical characteristics (curves)** 2.1





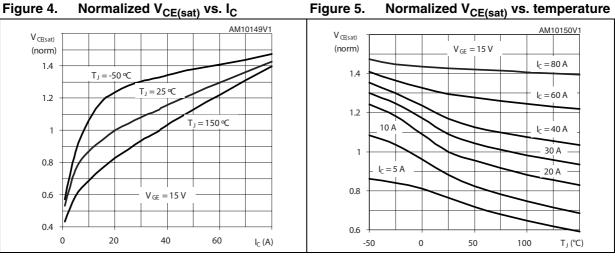


Figure 6. Normalized breakdown voltage vs. Figure 7. temperature

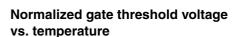
 $I_C = 1 \text{ mA}$ 

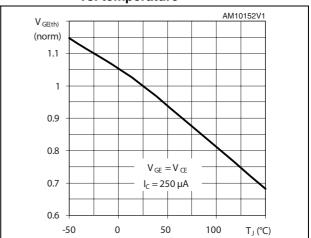
100

T」(°C)

50

AM10151V1





Doc ID 16090 Rev 3

57

 $V_{\text{CES}}$ (norm)

1.05

1

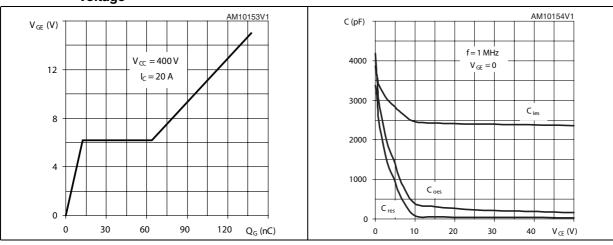
0.95

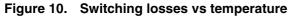
0.9

-50

0







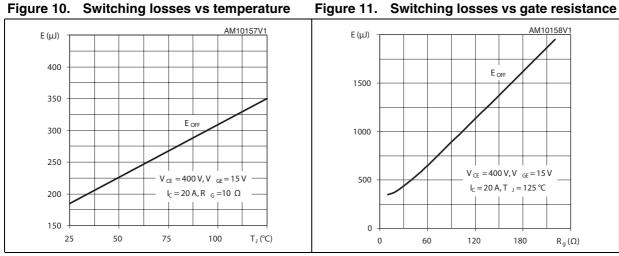


Figure 12. Switching losses vs collector current

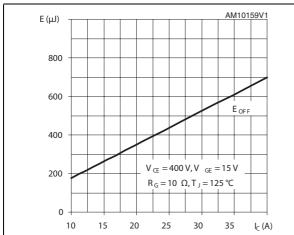
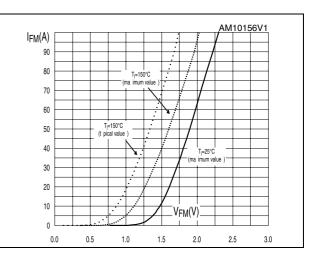
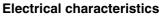
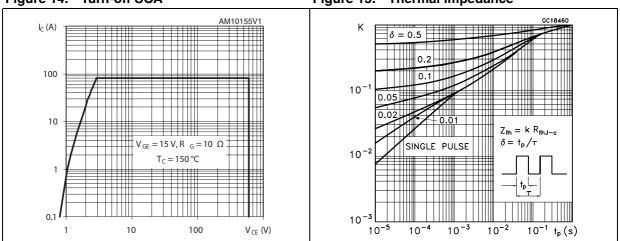


Figure 13. Diode forward on voltage









#### Figure 14. Turn-off SOA



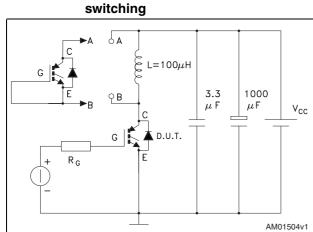


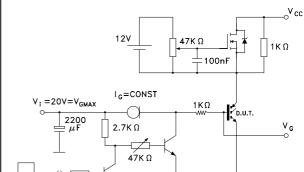
AM01505v1

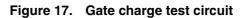
## 3 Test circuits

Figure 18. Switching waveform

Figure 16. Test circuit for inductive load



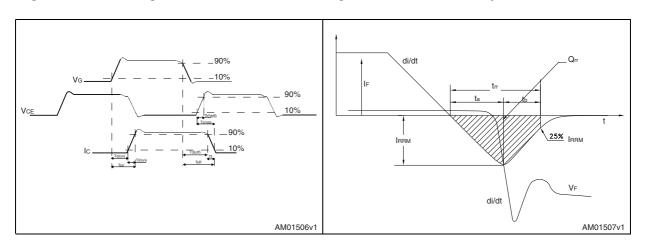






1K Ω

. Pw





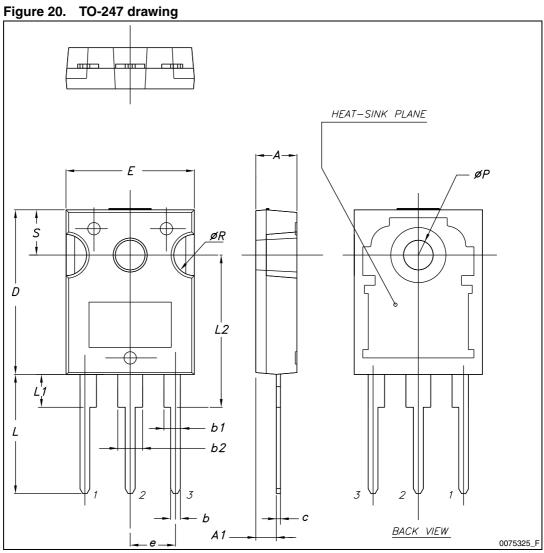
## 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

Dim.	mm			
	Min.	Тур.	Max.	
А	4.85		5.15	
A1	2.20		2.60	
b	1.0		1.40	
b1	2.0		2.40	
b2	3.0		3.40	
С	0.40		0.80	
D	19.85		20.15	
E	15.45		15.75	
е		5.45		
L	14.20		14.80	
L1	3.70		4.30	
L2		18.50		
ØP	3.55		3.65	
ØR	4.50		5.50	
S		5.50		

Table 9. TO-247 mechanical data



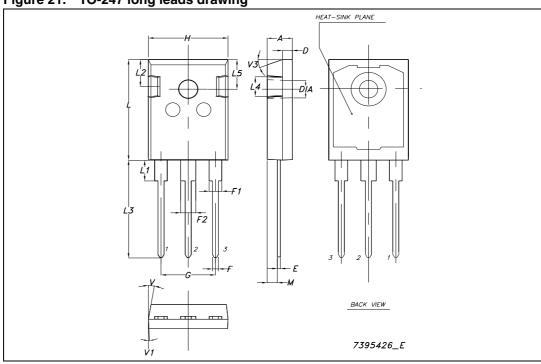




Dim	mm			
Dim. —	Min.	Тур.	Max.	
A	4.90		5.15	
D	1.85		2.10	
E	0.55		0.67	
F	1.07		1.32	
F1	1.90		2.38	
F2	2.87		3.38	
G	10.90 BSC			
Н	15.77		16.02	
L	20.82		21.07	
L1	4.16		4.47	
L2	5.49		5.74	
L3	20.05		20.30	
L4	3.68		3.93	
L5	6.04		6.29	
М	2.27		2.52	
V		10°		
V1		3°		
V3		20°		
Dia.	3.55		3.66	

 Table 10.
 TO-247 long leads mechanical data









## 5 Revision history

#### Table 11. Document revision history

Date	Revision	Changes	
03-Aug-2009	1	Initial release.	
02-Sep-2009	2	Minor text changes throughout the document Removed watermark.	
25-Aug-2011	3	Inserted new Section 2.1: Electrical characteristics (curves). Updated Section 4: Package mechanical data. Minor text changes.	



#### Please Read Carefully:

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time, without notice.

All ST products are sold pursuant to ST's terms and conditions of sale.

Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted under this document. If any part of this document refers to any third party products or services it shall not be deemed a license grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or any intellectual property contained therein.

UNLESS OTHERWISE SET FORTH IN ST'S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/OR SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

UNLESS EXPRESSLY APPROVED IN WRITING BY TWO AUTHORIZED ST REPRESENTATIVES, ST PRODUCTS ARE NOT RECOMMENDED, AUTHORIZED OR WARRANTED FOR USE IN MILITARY, AIR CRAFT, SPACE, LIFE SAVING, OR LIFE SUSTAINING APPLICATIONS, NOR IN PRODUCTS OR SYSTEMS WHERE FAILURE OR MALFUNCTION MAY RESULT IN PERSONAL INJURY, DEATH, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE. ST PRODUCTS WHICH ARE NOT SPECIFIED AS "AUTOMOTIVE GRADE" MAY ONLY BE USED IN AUTOMOTIVE APPLICATIONS AT USER'S OWN RISK.

Resale of ST products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST.

ST and the ST logo are trademarks or registered trademarks of ST in various countries.

Information in this document supersedes and replaces all information previously supplied.

The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners.

© 2011 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan -Malaysia - Malta - Morocco - Philippines - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

www.st.com



Doc ID 16090 Rev 3